

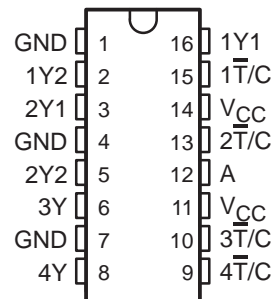
# CDC329A

## 1-LINE TO 6-LINE CLOCK DRIVER WITH SELECTABLE POLARITY

SCAS328B – DECEMBER 1992 – REVISED OCTOBER 1998

- Low Output Skew for Clock-Distribution and Clock-Generation Applications
- TTL-Compatible Inputs and CMOS-Compatible Outputs
- Distributes One Clock Input to Six Clock Outputs
- Polarity Control Selects True or Complementary Outputs
- Distributed  $V_{CC}$  and GND Pins Reduce Switching Noise
- High-Drive Outputs ( $-32\text{-mA } I_{OH}$ ,  $32\text{-mA } I_{OL}$ )
- State-of-the-Art *EPIC-II B*<sup>™</sup> BiCMOS Design Significantly Reduces Power Dissipation
- Package Options Include Plastic Small-Outline (D)

D PACKAGE  
(TOP VIEW)



### description

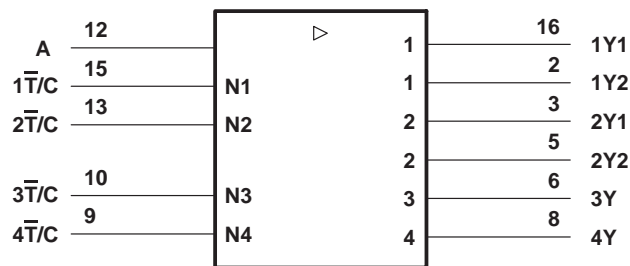
The CDC329A contains a clock-driver circuit that distributes one input signal to six outputs with minimum skew for clock distribution. Through the use of the polarity-control inputs ( $\overline{T/C}$ ), various combinations of true and complementary outputs can be obtained.

The CDC329A is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

FUNCTION TABLE

INPUTS		OUTPUT Y
$\overline{T/C}$	A	
L	L	L
L	H	H
H	L	H
H	H	L

### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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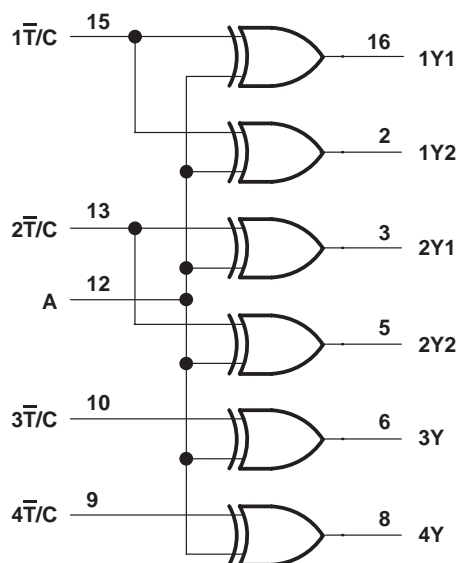
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**logic diagram (positive logic)**



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$ (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Current into any output in the low state, $I_O$	64 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2)	0.77 W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 300 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

# CDC329A

## 1-LINE TO 6-LINE CLOCK DRIVER WITH SELECTABLE POLARITY

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### recommended operating conditions (see Note 3)

	MIN	NOM	MAX	UNIT
$V_{CC}$ Supply voltage	4.75	5	5.25	V
$V_{IH}$ High-level input voltage	2			V
$V_{IL}$ Low-level input voltage			0.8	V
$V_I$ Input voltage	0	$V_{CC}$		V
$I_{OH}$ High-level output current			–32	mA
$I_{OL}$ Low-level output current			32	mA
$\Delta t/\Delta v$ Input transition rise or fall rate			5	ns/V
$f_{clock}$ Input clock frequency			80	MHz
$T_A$ Operating free-air temperature	–40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP†	MAX	UNIT
V <sub>IK</sub>	V <sub>CC</sub> = 4.75 V, I <sub>I</sub> = −18 mA					−1.2	V
V <sub>OH</sub>	V <sub>CC</sub> = 4.75 V, I <sub>OH</sub> = − 32 mA			3.85			V
V <sub>OL</sub>	V <sub>CC</sub> = 4.75 V, I <sub>OL</sub> = 32 mA					0.55	V
I <sub>I</sub>	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = V <sub>CC</sub> or GND					±1	μA
I <sub>CC</sub>	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0,	Outputs high			10	mA
			Outputs low			40	
C <sub>i</sub>	V <sub>I</sub> = 2.5 V or 0.5 V					3	pF

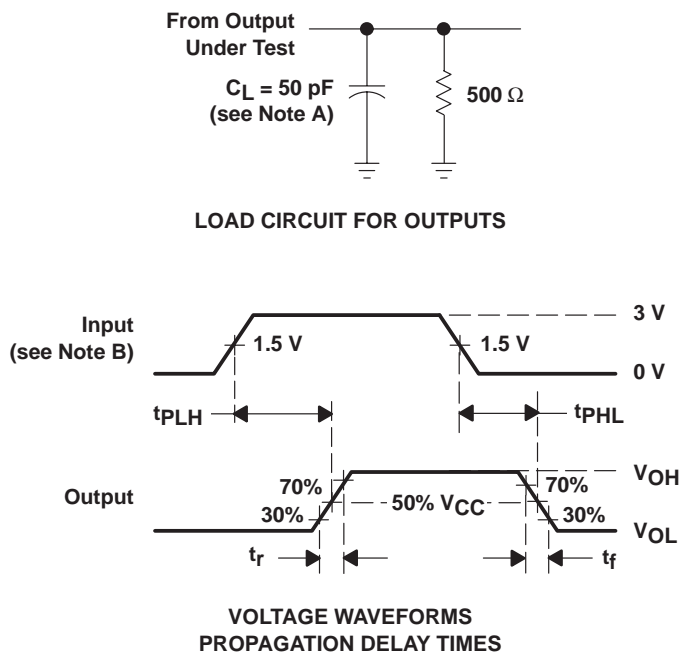
† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	TYP	MAX	UNIT
$t_{PLH}$	A	Any Y	2		5.9	ns
$t_{PHL}$			1.7		5.9	
$t_{PLH}$	$\bar{T}/C$	Any Y	1.5		5	ns
$t_{PHL}$			1.5		5	
$t_{sk(o)}$	A	Any Y (same phase)			0.6	ns
		Any Y (any phase)			1.5	
$t_r$				1.3		ns
$t_f$				0.85		ns



## PARAMETER MEASUREMENT INFORMATION

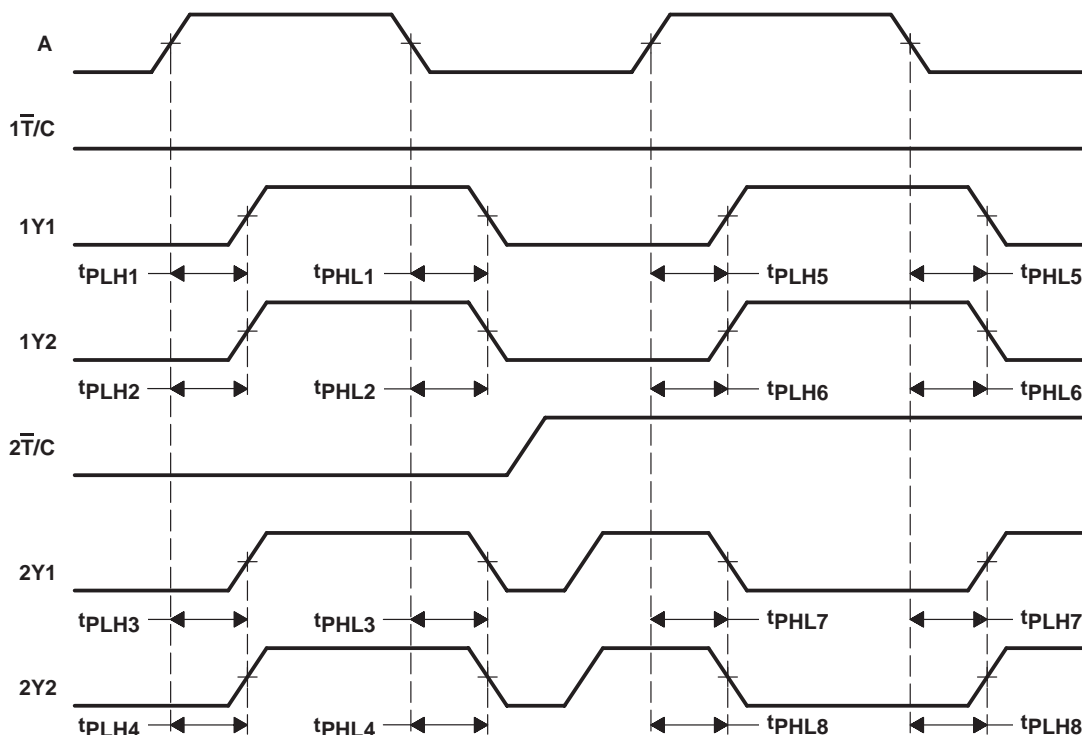


NOTES: A.  $C_L$  includes probe and jig capacitance.

B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .

**Figure 1. Load Circuit and Voltage Waveforms**

## PARAMETER MEASUREMENT INFORMATION



- NOTES: A. Output skew,  $t_{sk(o)}$ , from A to any Y (same phase), can be measured only between outputs for which the respective polarity-control inputs ( $\overline{T/C}$ ) are at the same logic level. It is calculated as the greater of:
- The difference between the fastest and slowest of  $t_{PHL}$  from  $A\downarrow$  to any Y (e.g.,  $t_{PHLn}$ ,  $n = 1$  to 4; or  $t_{PHLn}$ ,  $n = 5$  to 6)
  - The difference between the fastest and slowest of  $t_{PLH}$  from  $A\downarrow$  to any Y (e.g.,  $t_{PLHn}$ ,  $n = 1$  to 4; or  $t_{PLHn}$ ,  $n = 5$  to 6)
  - The difference between the fastest and slowest of  $t_{PLH}$  from  $A\downarrow$  to any Y (e.g.,  $t_{PLHn}$ ,  $n = 7$  to 8)
  - The difference between the fastest and slowest of  $t_{PHL}$  from  $A\uparrow$  to any Y (e.g.,  $t_{PHLn}$ ,  $n = 7$  to 8)
- B. Output skew,  $t_{sk(o)}$ , from A to any Y (any phase), can be measured between outputs for which the respective polarity-control inputs ( $\overline{T/C}$ ) are at the same or different logic levels. It is calculated as the greater of:
- The difference between the fastest and slowest of  $t_{PLH}$  from  $A\uparrow$  to any Y or  $t_{PHL}$  from  $A\uparrow$  to any Y (e.g.,  $t_{PLHn}$ ,  $n = 1$  to 4; or  $t_{PLHn}$ ,  $n = 5$  to 6, and  $t_{PHLn}$ ,  $n = 7$  to 8)
  - The difference between the fastest and slowest of  $t_{PHL}$  from  $A\downarrow$  to any Y or  $t_{PLH}$  from  $A\downarrow$  to any Y (e.g.,  $t_{PHLn}$ ,  $n = 1$  to 4; or  $t_{PHLn}$ ,  $n = 5$  to 6, and  $t_{PLHn}$ ,  $n = 7$  to 8)

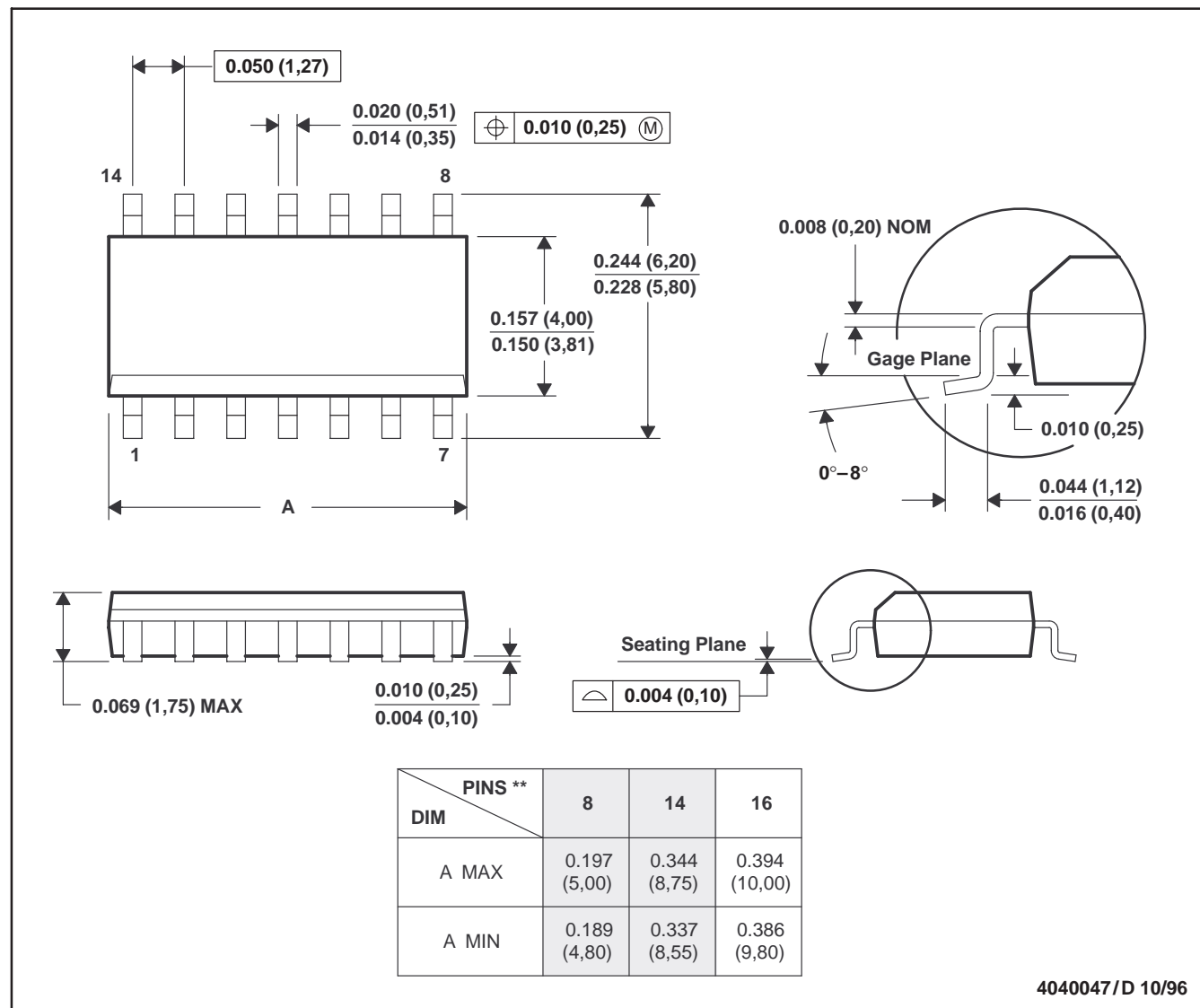
**Figure 2. Waveforms for Calculation of  $t_{sk(o)}$**

## MECHANICAL INFORMATION

**D (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-012

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CDC329AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC329ADBLE	OBSOLETE	SSOP	DB	16		TBD	Call TI	Call TI
CDC329ADG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC329ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC329ADRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

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**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CDC329ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1



## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CDC329ADR	SOIC	D	16	2500	346.0	346.0	33.0

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